

MC33201, MC33202, MC33204, NCV33202, NCV33204

Low Voltage, Rail-to-Rail Operational Amplifiers

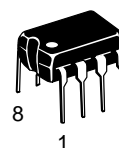
The MC33201/2/4 family of operational amplifiers provide rail-to-rail operation on both the input and output. The inputs can be driven as high as 200 mV beyond the supply rails without phase reversal on the outputs, and the output can swing within 50 mV of each rail. This rail-to-rail operation enables the user to make full use of the supply voltage range available. It is designed to work at very low supply voltages (± 0.9 V) yet can operate with a supply of up to +12 V and ground. Output current boosting techniques provide a high output current capability while keeping the drain current of the amplifier to a minimum. Also, the combination of low noise and distortion with a high slew rate and drive capability make this an ideal amplifier for audio applications.

- Low Voltage, Single Supply Operation
(+1.8 V and Ground to +12 V and Ground)
- Input Voltage Range Includes both Supply Rails
- Output Voltage Swings within 50 mV of both Rails
- No Phase Reversal on the Output for Over-driven Input Signals
- High Output Current ($I_{SC} = 80$ mA, Typ)
- Low Supply Current ($I_D = 0.9$ mA, Typ)
- 600 Ω Output Drive Capability
- Extended Operating Temperature Ranges
(-40° to $+105^\circ\text{C}$ and -55° to $+125^\circ\text{C}$)
- Typical Gain Bandwidth Product = 2.2 MHz
- Pb-Free Packages are Available



ON Semiconductor®

<http://onsemi.com>



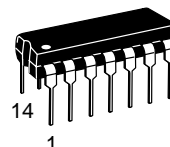
PDIP-8
P, VP SUFFIX
CASE 626



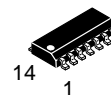
SOIC-8
D, VD SUFFIX
CASE 751



Micro8™
DM SUFFIX
CASE 846A



PDIP-14
P, VP SUFFIX
CASE 646



SOIC-14
D, VD SUFFIX
CASE 751A



TSSOP-14
DTB SUFFIX
CASE 948G

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 10 of this data sheet.

DEVICE MARKING INFORMATION

See general marking information in the device marking section on page 11 of this data sheet.

MC33201, MC33202, MC33204, NCV33202, NCV33204

PIN CONNECTIONS

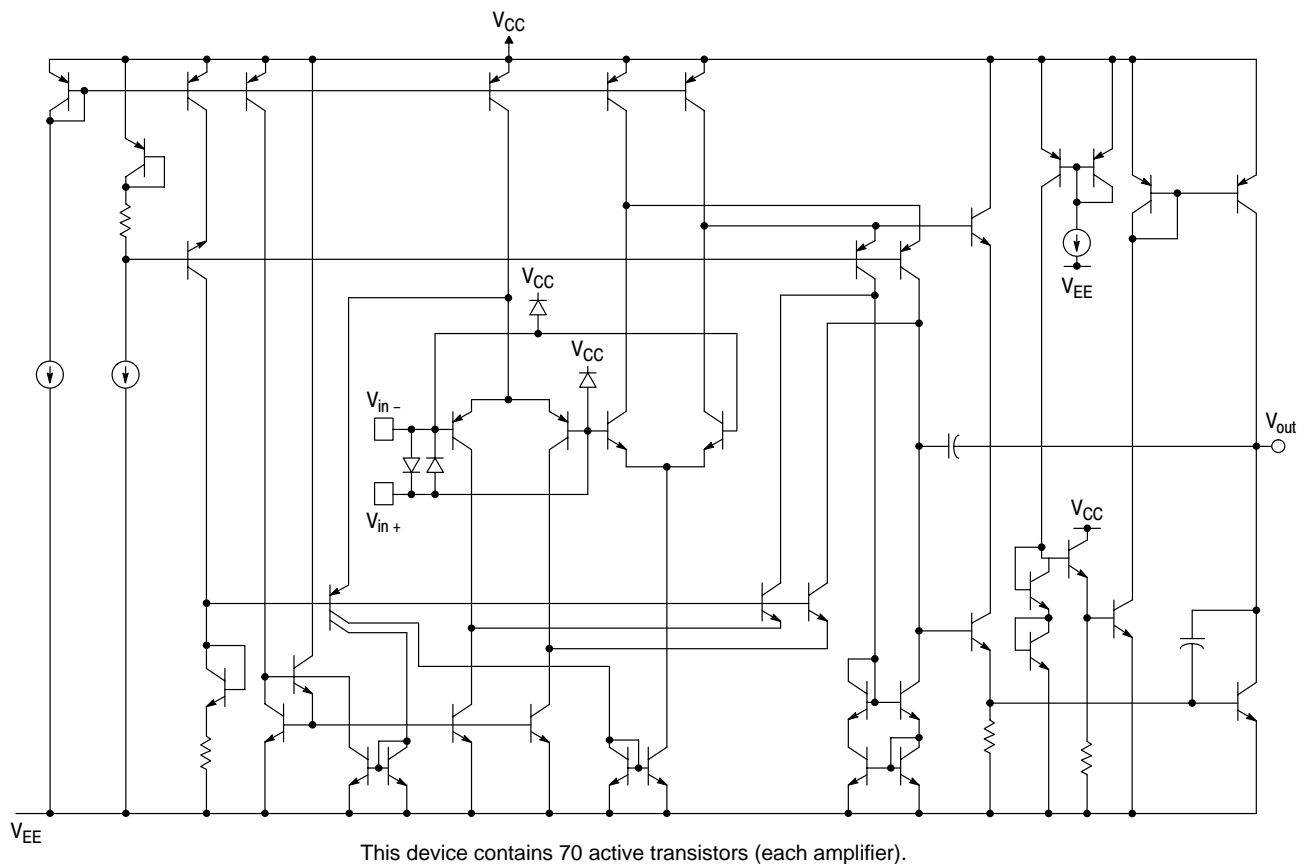
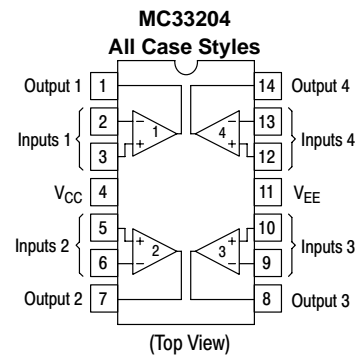
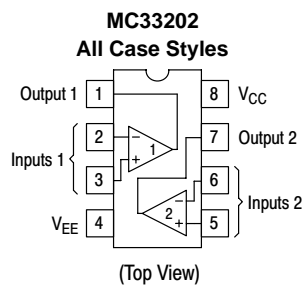
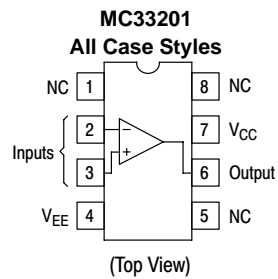


Figure 1. Circuit Schematic
(Each Amplifier)

MC33201, MC33202, MC33204, NCV33202, NCV33204

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|--|-----------|--------------------------------------|------|
| Supply Voltage (V_{CC} to V_{EE}) | V_S | +13 | V |
| Input Differential Voltage Range | V_{IDR} | Note 1 | V |
| Common Mode Input Voltage Range (Note 2) | V_{CM} | $V_{CC} + 0.5$ V to $V_{EE} - 0.5$ V | V |
| Output Short Circuit Duration | t_s | Note 3 | sec |
| Maximum Junction Temperature | T_J | +150 | °C |
| Storage Temperature | T_{stg} | – 65 to +150 | °C |
| Maximum Power Dissipation | P_D | Note 3 | mW |

DC ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$)

| Characteristic | $V_{CC} = 2.0$ V | $V_{CC} = 3.3$ V | $V_{CC} = 5.0$ V | Unit |
|--|-----------------------------------|-----------------------------------|------------------------------------|------------------------|
| Input Offset Voltage $V_{IO(max)}$ MC33201 MC33202, NCV33202 MC33204 | ± 8.0 ± 10 ± 12 | ± 8.0 ± 10 ± 12 | ± 6.0 ± 8.0 ± 10 | mV |
| Output Voltage Swing V_{OH} ($R_L = 10$ k Ω) V_{OL} ($R_L = 10$ k Ω) | 1.9 0.10 | 3.15 0.15 | 4.85 0.15 | V_{min} V_{max} |
| Power Supply Current per Amplifier (I_D) | 1.125 | 1.125 | 1.125 | mA |

Specifications at $V_{CC} = 3.3$ V are guaranteed by the 2.0 V and 5.0 V tests. $V_{EE} = \text{GND}$.

DC ELECTRICAL CHARACTERISTICS ($V_{CC} = +5.0$ V, $V_{EE} = \text{Ground}$, $T_A = 25^\circ\text{C}$, unless otherwise noted.)

| Characteristic | Figure | Symbol | Min | Typ | Max | Unit |
|--|--------|--------------------------|--|--|---|------------------------------|
| Input Offset Voltage ($V_{CM} = 0$ V to 0.5 V, $V_{CM} = 1.0$ V to 5.0 V) MC33201: $T_A = +25^\circ\text{C}$ MC33201: $T_A = -40^\circ$ to $+105^\circ\text{C}$ MC33201V: $T_A = -55^\circ$ to $+125^\circ\text{C}$ MC33202: $T_A = +25^\circ\text{C}$ MC33202: $T_A = -40^\circ$ to $+105^\circ\text{C}$ MC33202V: $T_A = -55^\circ$ to $+125^\circ\text{C}$ NCV33202V: $T_A = -55^\circ$ to $+125^\circ\text{C}$ (Note 4) MC33204: $T_A = +25^\circ\text{C}$ MC33204: $T_A = -40^\circ$ to $+105^\circ\text{C}$ MC33204V: $T_A = -55^\circ$ to $+125^\circ\text{C}$ | 3 | $ V_{IO} $ | – – – – – – – – – – | – – – – – – – – – – | 6.0 9.0 13 8.0 11 14 14 10 13 17 | mV |
| Input Offset Voltage Temperature Coefficient ($R_S = 50$ Ω) $T_A = -40^\circ$ to $+105^\circ\text{C}$ $T_A = -55^\circ$ to $+125^\circ\text{C}$ | 4 | $\Delta V_{IO}/\Delta T$ | – – | 2.0 2.0 | – – | $\mu\text{V}/^\circ\text{C}$ |
| Input Bias Current ($V_{CM} = 0$ V to 0.5 V, $V_{CM} = 1.0$ V to 5.0 V) $T_A = +25^\circ\text{C}$ $T_A = -40^\circ$ to $+105^\circ\text{C}$ $T_A = -55^\circ$ to $+125^\circ\text{C}$ | 5, 6 | $ I_{IB} $ | – – – | 80 100 – | 200 250 500 | nA |
| Input Offset Current ($V_{CM} = 0$ V to 0.5 V, $V_{CM} = 1.0$ V to 5.0 V) $T_A = +25^\circ\text{C}$ $T_A = -40^\circ$ to $+105^\circ\text{C}$ $T_A = -55^\circ$ to $+125^\circ\text{C}$ | – | $ I_{IO} $ | – – – | 5.0 10 – | 50 100 200 | nA |
| Common Mode Input Voltage Range | – | V_{ICR} | V_{EE} | – | V_{CC} | V |

- The differential input voltage of each amplifier is limited by two internal parallel back-to-back diodes. For additional differential input voltage range, use current limiting resistors in series with the input pins.
- The input common mode voltage range is limited by internal diodes connected from the inputs to both supply rails. Therefore, the voltage on either input must not exceed either supply rail by more than 500 mV.
- Power dissipation must be considered to ensure maximum junction temperature (T_J) is not exceeded. (See Figure 2)
- NCV33202 and NCV33204 are qualified for automotive use.

MC33201, MC33202, MC33204, NCV33202, NCV33204

DC ELECTRICAL CHARACTERISTICS (cont.) ($V_{CC} = +5.0\text{ V}$, $V_{EE} = \text{Ground}$, $T_A = 25^\circ\text{C}$, unless otherwise noted.)

| Characteristic | Figure | Symbol | Min | Typ | Max | Unit |
|--|----------|--|------------------------|------------------------------|------------------------|-----------------|
| Large Signal Voltage Gain ($V_{CC} = +5.0\text{ V}$, $V_{EE} = -5.0\text{ V}$) $R_L = 10\text{ k}\Omega$ $R_L = 600\ \Omega$ | 7 | A_{VOL} | 50 25 | 300 250 | – – | kV/V |
| Output Voltage Swing ($V_{ID} = \pm 0.2\text{ V}$) $R_L = 10\text{ k}\Omega$ $R_L = 10\text{ k}\Omega$ $R_L = 600\ \Omega$ $R_L = 600\ \Omega$ | 8, 9, 10 | V_{OH} V_{OL} V_{OH} V_{OL} | 4.85 – 4.75 – | 4.95 0.05 4.85 0.15 | – 0.15 – 0.25 | V |
| Common Mode Rejection ($V_{in} = 0\text{ V}$ to 5.0 V) | 11 | CMR | 60 | 90 | – | dB |
| Power Supply Rejection Ratio $V_{CC}/V_{EE} = 5.0\text{ V/GND}$ to 3.0 V/GND | 12 | PSRR | 500 | 25 | – | $\mu\text{V/V}$ |
| Output Short Circuit Current (Source and Sink) | 13, 14 | I_{SC} | 50 | 80 | – | mA |
| Power Supply Current per Amplifier ($V_O = 0\text{ V}$) $T_A = -40^\circ$ to $+105^\circ\text{C}$ $T_A = -55^\circ$ to $+125^\circ\text{C}$ | 15 | I_D | – – | 0.9 0.9 | 1.125 1.125 | mA |

AC ELECTRICAL CHARACTERISTICS ($V_{CC} = +5.0\text{ V}$, $V_{EE} = \text{Ground}$, $T_A = 25^\circ\text{C}$, unless otherwise noted.)

| Characteristic | Figure | Symbol | Min | Typ | Max | Unit |
|--|------------|----------|--------|----------------|--------|---------------------------|
| Slew Rate ($V_S = \pm 2.5\text{ V}$, $V_O = -2.0\text{ V}$ to $+2.0\text{ V}$, $R_L = 2.0\text{ k}\Omega$, $A_V = +1.0$) | 16, 26 | SR | 0.5 | 1.0 | – | V/ μs |
| Gain Bandwidth Product ($f = 100\text{ kHz}$) | 17 | GBW | – | 2.2 | – | MHz |
| Gain Margin ($R_L = 600\ \Omega$, $C_L = 0\text{ pF}$) | 20, 21, 22 | A_M | – | 12 | – | dB |
| Phase Margin ($R_L = 600\ \Omega$, $C_L = 0\text{ pF}$) | 20, 21, 22 | ϕ_M | – | 65 | – | Deg |
| Channel Separation ($f = 1.0\text{ Hz}$ to 20 kHz , $A_V = 100$) | 23 | CS | – | 90 | – | dB |
| Power Bandwidth ($V_O = 4.0\text{ V}_{pp}$, $R_L = 600\ \Omega$, $\text{THD} \leq 1\%$) | | BW_P | – | 28 | – | kHz |
| Total Harmonic Distortion ($R_L = 600\ \Omega$, $V_O = 1.0\text{ V}_{pp}$, $A_V = 1.0$) $f = 1.0\text{ kHz}$ $f = 10\text{ kHz}$ | 24 | THD | – – | 0.002 0.008 | – – | % |
| Open Loop Output Impedance ($V_O = 0\text{ V}$, $f = 2.0\text{ MHz}$, $A_V = 10$) | | $ Z_O $ | – | 100 | – | Ω |
| Differential Input Resistance ($V_{CM} = 0\text{ V}$) | | R_{in} | – | 200 | – | k Ω |
| Differential Input Capacitance ($V_{CM} = 0\text{ V}$) | | C_{in} | – | 8.0 | – | pF |
| Equivalent Input Noise Voltage ($R_S = 100\ \Omega$) $f = 10\text{ Hz}$ $f = 1.0\text{ kHz}$ | 25 | e_n | – – | 25 20 | – – | nV/ $\sqrt{\text{Hz}}$ |
| Equivalent Input Noise Current $f = 10\text{ Hz}$ $f = 1.0\text{ kHz}$ | 25 | i_n | – – | 0.8 0.2 | – – | pA/ $\sqrt{\text{Hz}}$ |

MC33201, MC33202, MC33204, NCV33202, NCV33204

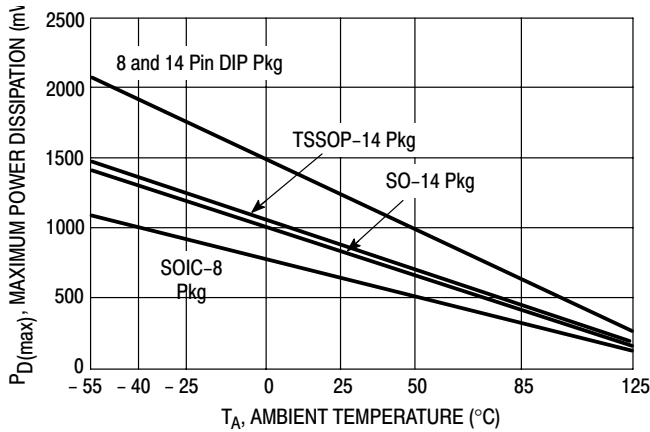


Figure 2. Maximum Power Dissipation versus Temperature

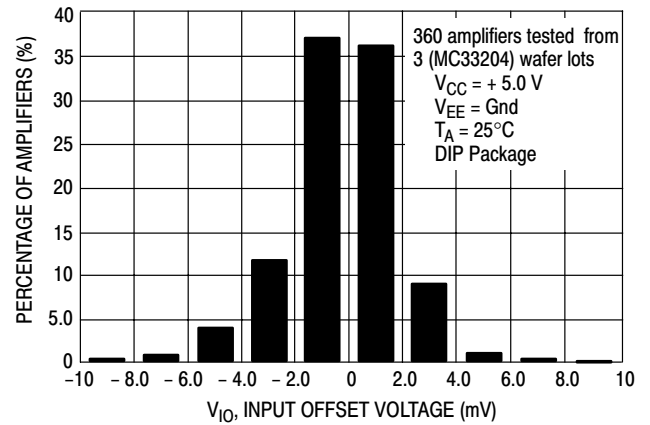


Figure 3. Input Offset Voltage Distribution

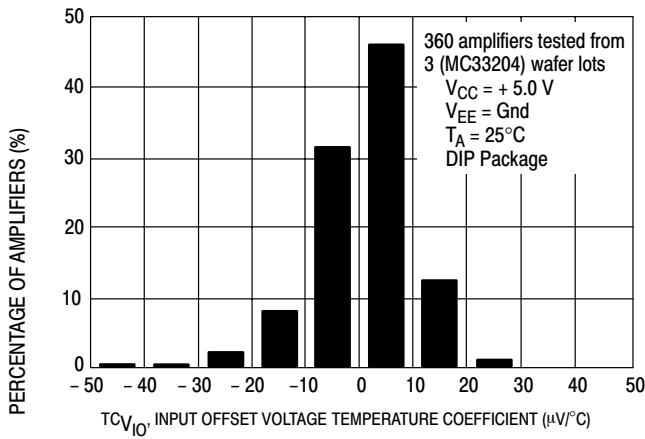


Figure 4. Input Offset Voltage Temperature Coefficient Distribution

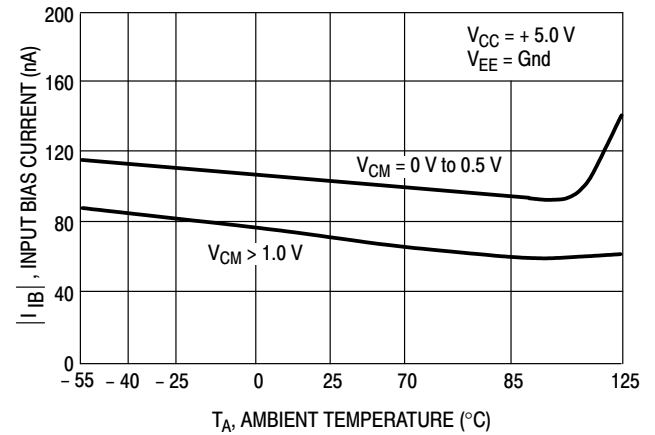


Figure 5. Input Bias Current versus Temperature

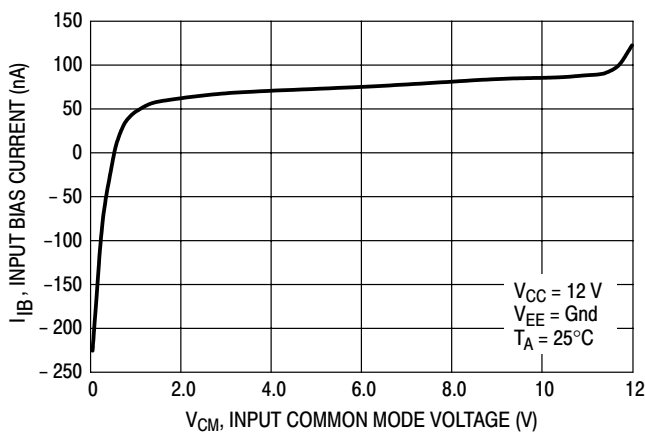


Figure 6. Input Bias Current versus Common Mode Voltage

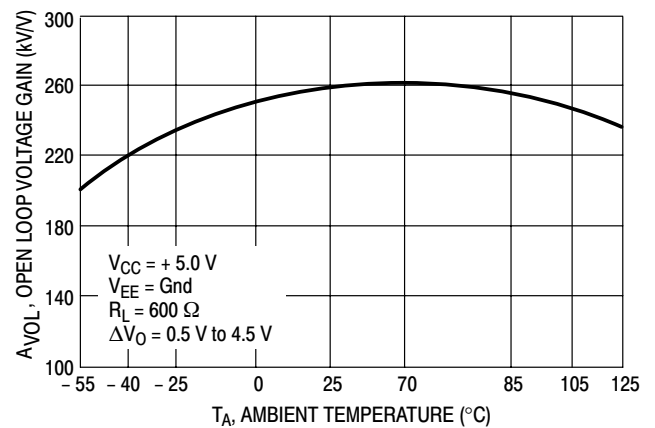


Figure 7. Open Loop Voltage Gain versus Temperature

MC33201, MC33202, MC33204, NCV33202, NCV33204

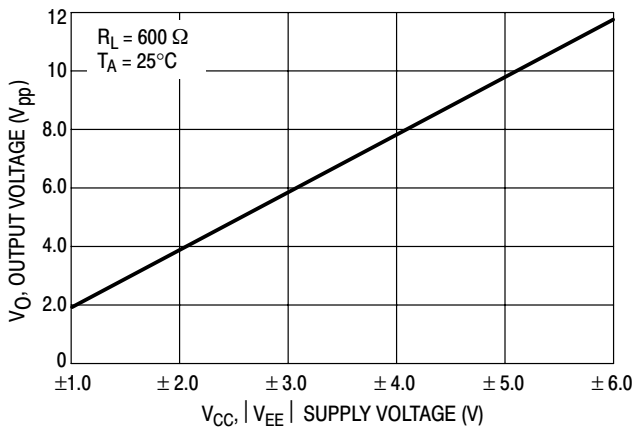


Figure 8. Output Voltage Swing versus Supply Voltage

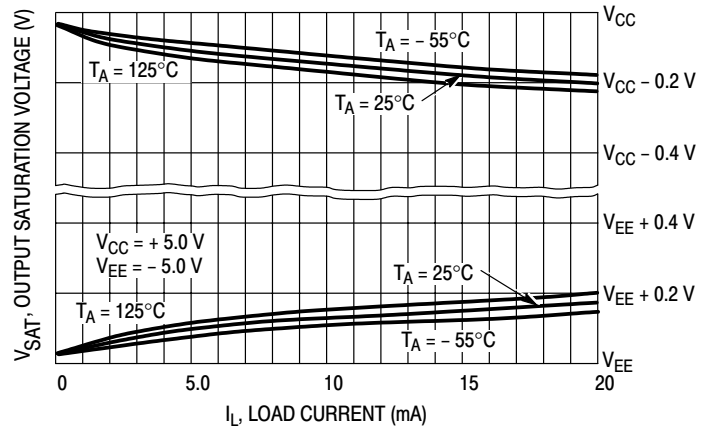


Figure 9. Output Saturation Voltage versus Load Current

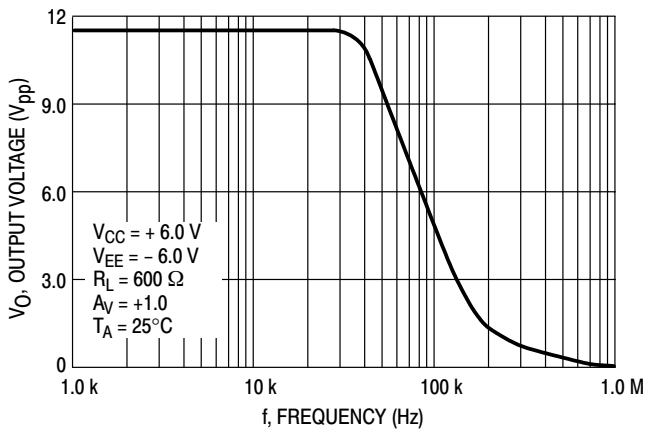


Figure 10. Output Voltage versus Frequency

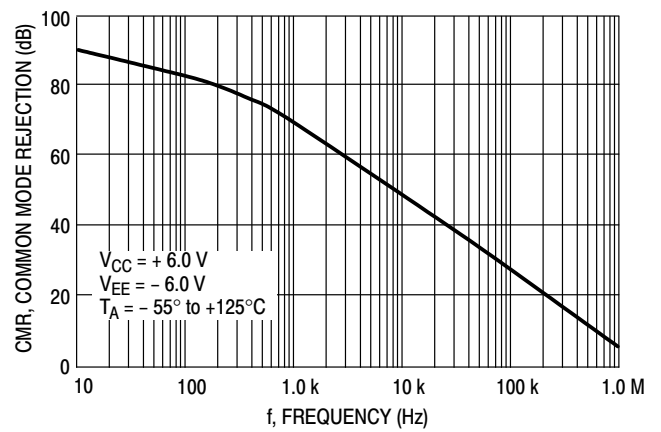


Figure 11. Common Mode Rejection versus Frequency

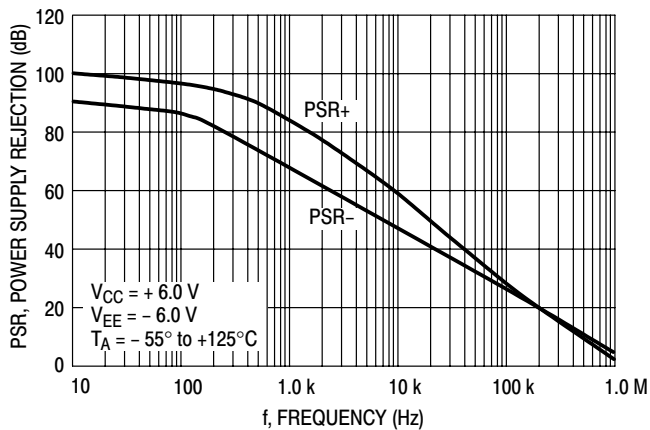


Figure 12. Power Supply Rejection versus Frequency

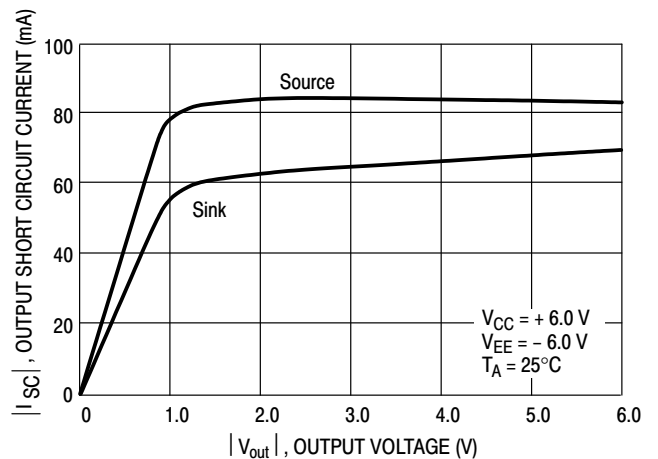


Figure 13. Output Short Circuit Current versus Output Voltage

MC33201, MC33202, MC33204, NCV33202, NCV33204

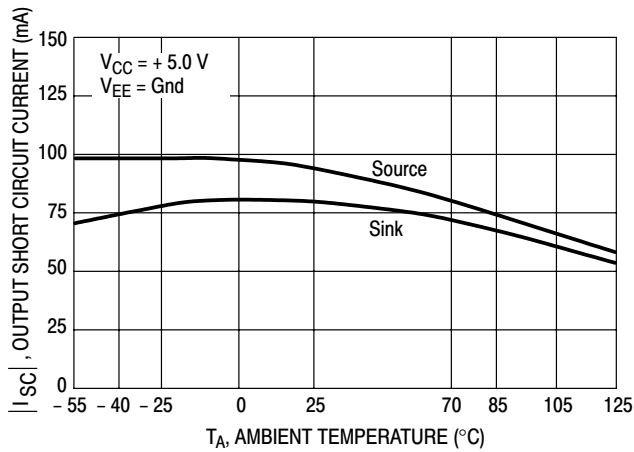


Figure 14. Output Short Circuit Current versus Temperature

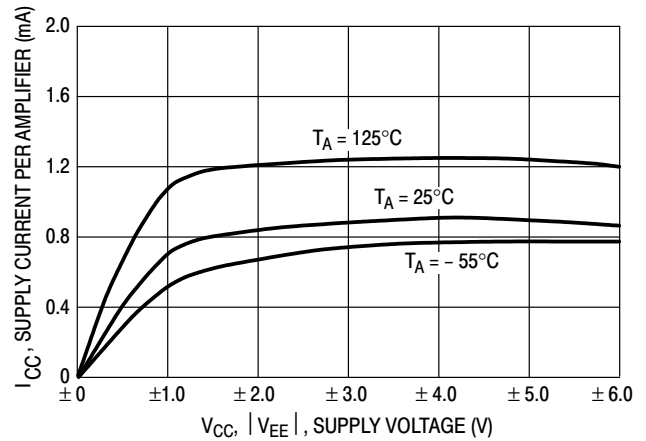


Figure 15. Supply Current per Amplifier versus Supply Voltage with No Load

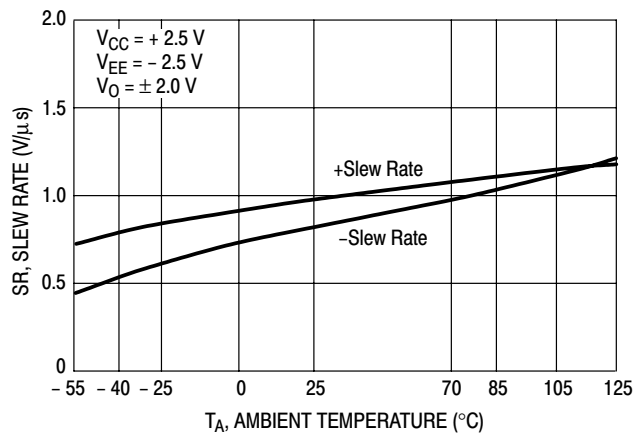


Figure 16. Slew Rate versus Temperature

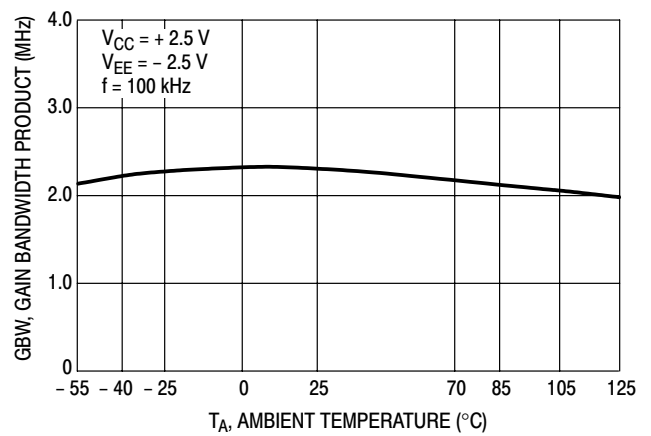


Figure 17. Gain Bandwidth Product versus Temperature

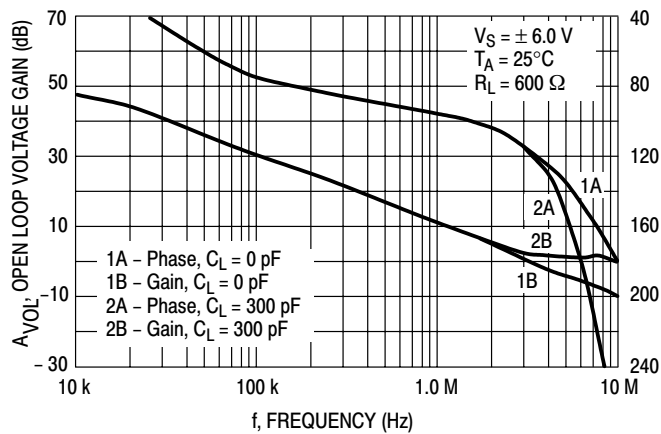


Figure 18. Voltage Gain and Phase versus Frequency

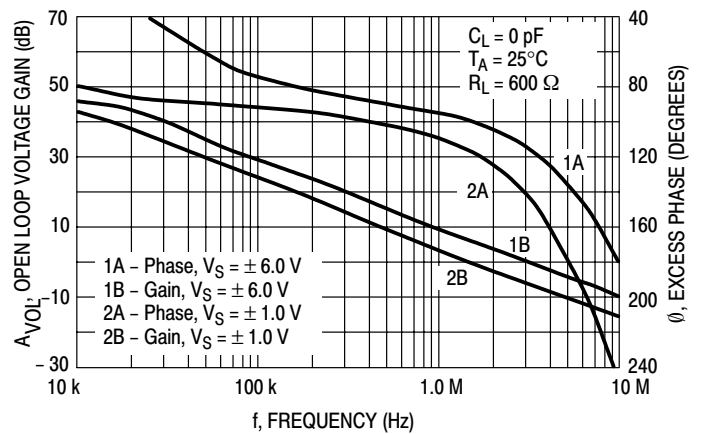


Figure 19. Voltage Gain and Phase versus Frequency

MC33201, MC33202, MC33204, NCV33202, NCV33204

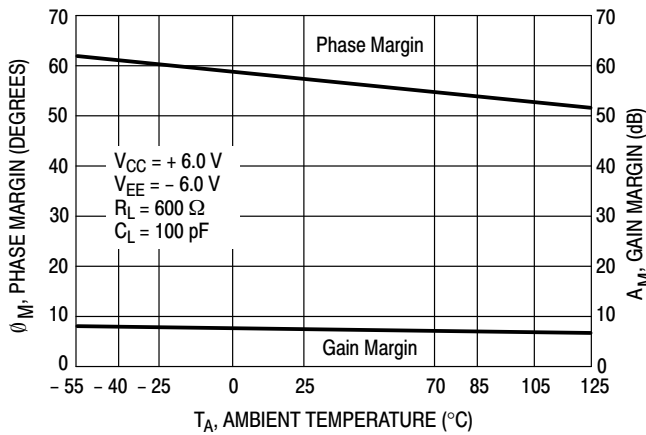


Figure 20. Gain and Phase Margin versus Temperature

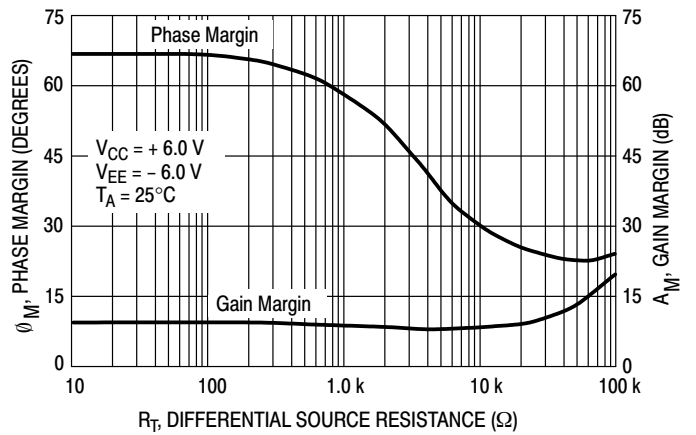


Figure 21. Gain and Phase Margin versus Differential Source Resistance

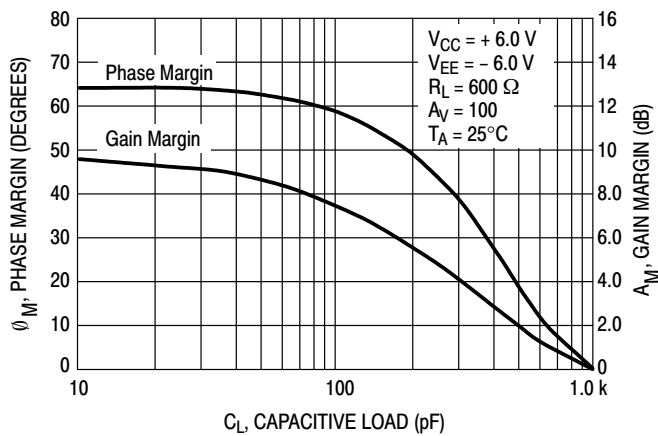


Figure 22. Gain and Phase Margin versus Capacitive Load

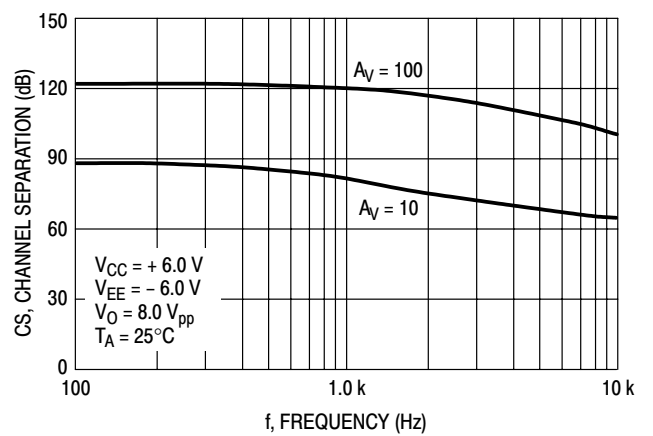


Figure 23. Channel Separation versus Frequency

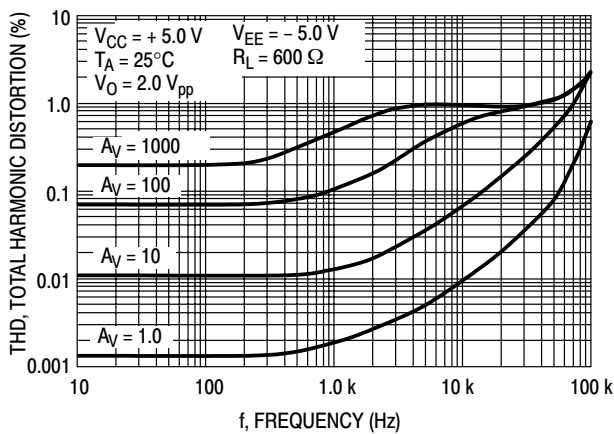


Figure 24. Total Harmonic Distortion versus Frequency

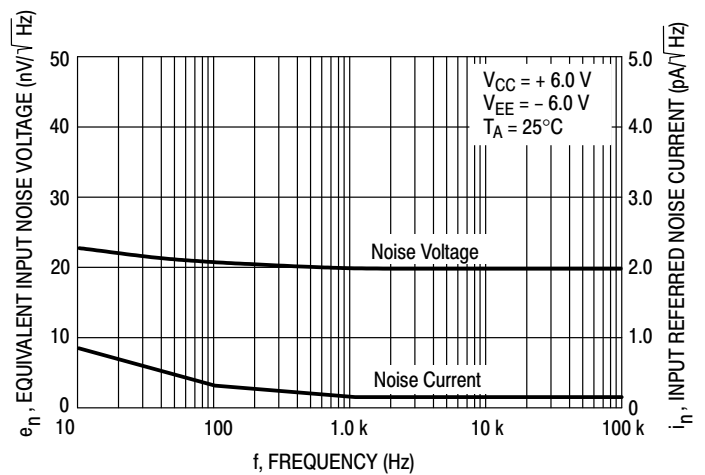


Figure 25. Equivalent Input Noise Voltage and Current versus Frequency

MC33201, MC33202, MC33204, NCV33202, NCV33204

DETAILED OPERATING DESCRIPTION

General Information

The MC33201/2/4 family of operational amplifiers are unique in their ability to swing rail-to-rail on both the input and the output with a completely bipolar design. This offers low noise, high output current capability and a wide common mode input voltage range even with low supply voltages. Operation is guaranteed over an extended temperature range and at supply voltages of 2.0 V, 3.3 V and 5.0 V and ground.

Since the common mode input voltage range extends from V_{CC} to V_{EE} , it can be operated with either single or split voltage supplies. The MC33201/2/4 are guaranteed not to latch or phase reverse over the entire common mode range, however, the inputs should not be allowed to exceed maximum ratings.

Circuit Information

Rail-to-rail performance is achieved at the input of the amplifiers by using parallel NPN-PNP differential input stages. When the inputs are within 800 mV of the negative rail, the PNP stage is on. When the inputs are more than 800 mV greater than V_{EE} , the NPN stage is on. This switching of input pairs will cause a reversal of input bias currents (see Figure 6). Also, slight differences in offset voltage may be noted between the NPN and PNP pairs. Cross-coupling techniques have been used to keep this change to a minimum.

In addition to its rail-to-rail performance, the output stage is current boosted to provide 80 mA of output current, enabling the op amp to drive 600 Ω loads. Because of this high output current capability, care should be taken not to exceed the 150°C maximum junction temperature.

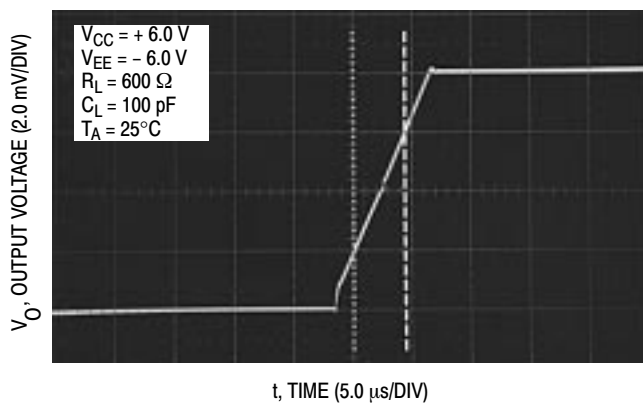


Figure 26. Noninverting Amplifier Slew Rate

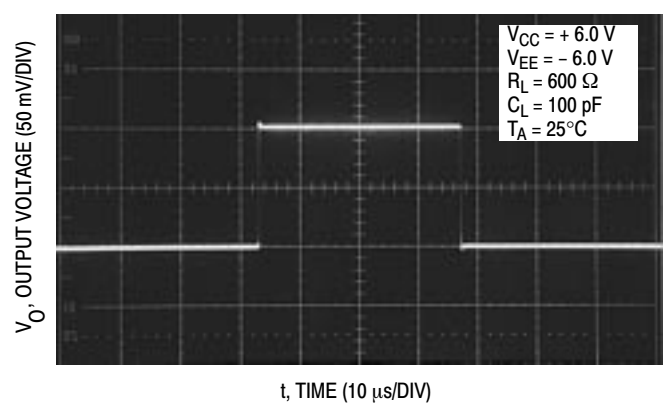


Figure 27. Small Signal Transient Response

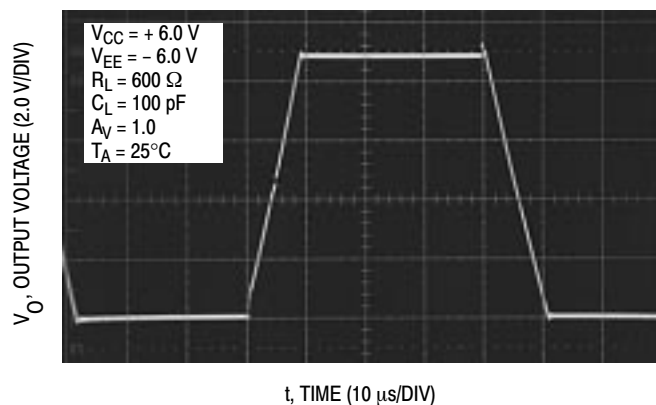


Figure 28. Large Signal Transient Response

Surface mount board layout is a critical portion of the total design. The footprint for the semiconductor packages must be the correct size to ensure proper solder connection interface

between the board and the package. With the correct pad geometry, the packages will self-align when subjected to a solder reflow process.

MC33201, MC33202, MC33204, NCV33202, NCV33204

ORDERING INFORMATION

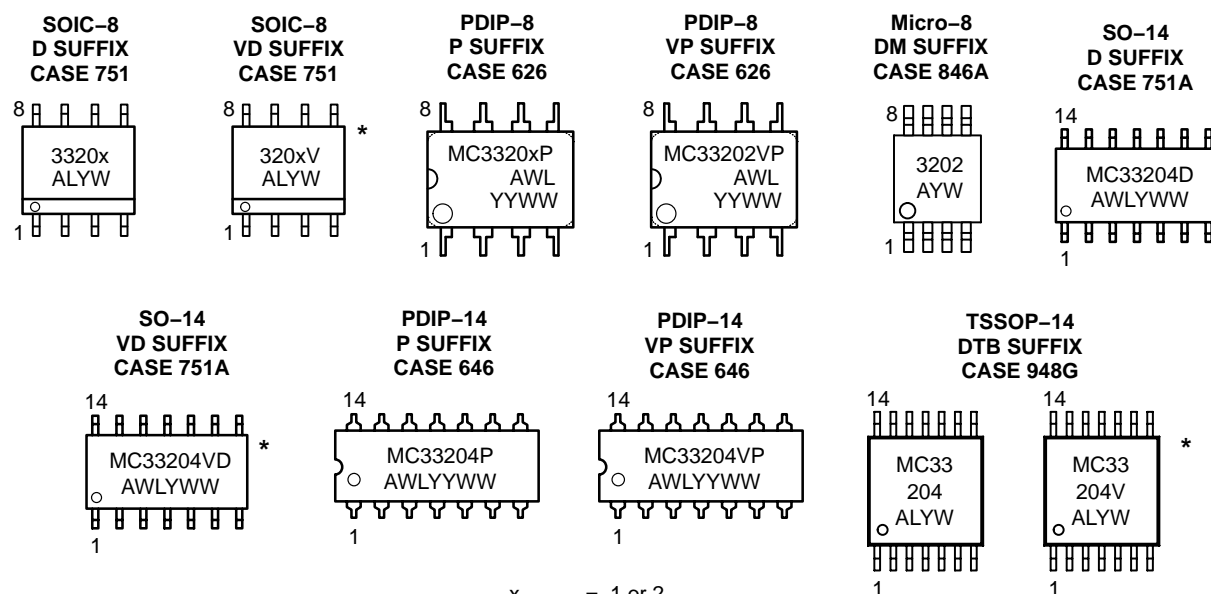
| Operational Amplifier Function | Device | Operating Temperature Range | Package | Shipping [†] |
|--------------------------------|----------------|---|------------------|--------------------------|
| Single | MC33201D | $T_A = -40^\circ \text{ to } +105^\circ \text{C}$ | SOIC-8 | 98 Units / Rail |
| | MC33201DR2 | | SOIC-8 | 2500 Units / Tape & Reel |
| | MC33201P | | PDIP-8 | 50 Units / Rail |
| | MC33201VD | $T_A = -55^\circ \text{ to } 125^\circ \text{C}$ | SOIC-8 | 98 Units / Rail |
| Dual | MC33202D | $T_A = -40^\circ \text{ to } +105^\circ \text{C}$ | SOIC-8 | 98 Units / Rail |
| | MC33202DG | | SOIC-8 (Pb-Free) | |
| | MC33202DR2 | | SOIC-8 | 2500 Units / Tape & Reel |
| | MC33202DR2G | | SOIC-8 (Pb-Free) | |
| Dual | MC33202DMR2 | $T_A = -40^\circ \text{ to } +105^\circ \text{C}$ | Micro-8 | 4000 Units / Tape & Reel |
| | MC33202P | | PDIP-8 | 50 Units / Rail |
| | MC33202VD | $T_A = -55^\circ \text{ to } 125^\circ \text{C}$ | SOIC-8 | 98 Units / Rail |
| | MC33202VDR2 | | SOIC-8 | 2500 Units / Tape & Reel |
| | NCV33202VDR2* | | SOIC-8 | 2500 Units / Tape & Reel |
| | MC33202VP | | PDIP-8 | 50 Units / Rail |
| Quad | MC33204D | $T_A = -40^\circ \text{ to } +105^\circ \text{C}$ | SO-14 | 55 Units / Rail |
| | MC33204DR2 | | SO-14 | 2500 Units / Tape & Reel |
| | MC33204DTB | | TSSOP-14 | 96 Units / Rail |
| | MC33204DTBR2 | | TSSOP-14 | 2500 Units / Tape & Reel |
| | MC33204P | | PDIP-14 | 25 Units / Rail |
| | MC33204VD | $T_A = -55^\circ \text{ to } 125^\circ \text{C}$ | SO-14 | 55 Units / Rail |
| | MC33204VDR2 | | SO-14 | 2500 Units / Tape & Reel |
| | NCV33204DR2* | | SO-14 | 2500 Units / Tape & Reel |
| | NCV33204DTBR2* | | TSSOP-14 | 2500 Units / Tape & Reel |
| | MC33204VP | | PDIP-14 | 25 Units / Rail |

*NCV33202 and NCV33204 are qualified for automotive use.

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MC33201, MC33202, MC33204, NCV33202, NCV33204

MARKING DIAGRAMS



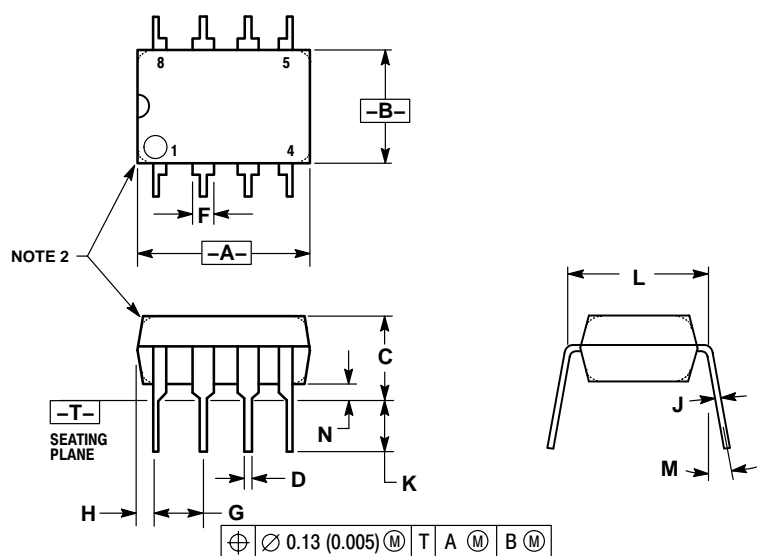
x = 1 or 2
A = Assembly Location
WL, L = Wafer Lot
YY, Y = Year
WW, W = Work Week

*This marking diagram applies to NCV3320x

MC33201, MC33202, MC33204, NCV33202, NCV33204

PACKAGE DIMENSIONS

PDIP-8
P, VP SUFFIX
CASE 626-05
ISSUE L



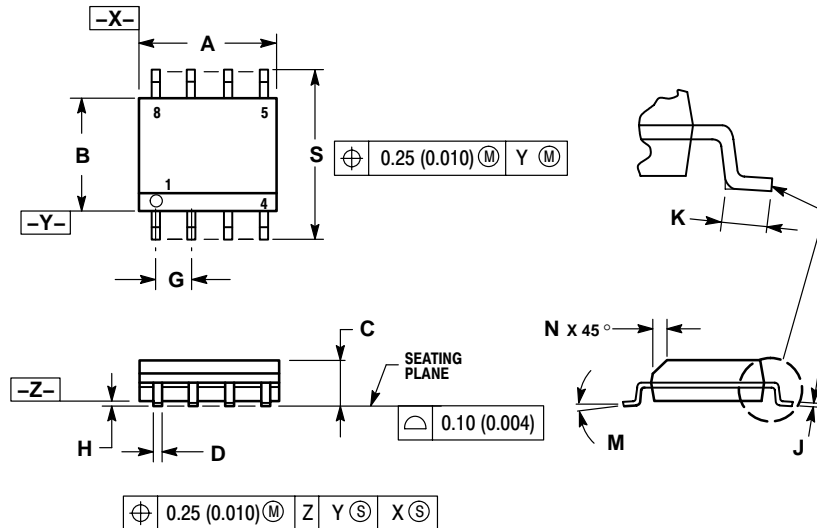
NOTES:

1. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
2. PACKAGE CONTOUR OPTIONAL (ROUND OR SQUARE CORNERS).
3. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

| DIM | MILLIMETERS | | INCHES | |
|-----|-------------|-------|-----------|-------|
| | MIN | MAX | MIN | MAX |
| A | 9.40 | 10.16 | 0.370 | 0.400 |
| B | 6.10 | 6.60 | 0.240 | 0.260 |
| C | 3.94 | 4.45 | 0.155 | 0.175 |
| D | 0.38 | 0.51 | 0.015 | 0.020 |
| F | 1.02 | 1.78 | 0.040 | 0.070 |
| G | 2.54 BSC | | 0.100 BSC | |
| H | 0.76 | 1.27 | 0.030 | 0.050 |
| J | 0.20 | 0.30 | 0.008 | 0.012 |
| K | 2.92 | 3.43 | 0.115 | 0.135 |
| L | 7.62 BSC | | 0.300 BSC | |
| M | --- | 10° | --- | 10° |
| N | 0.76 | 1.01 | 0.030 | 0.040 |

MC33201, MC33202, MC33204, NCV33202, NCV33204

SOIC-8 D, VD SUFFIX CASE 751-07 ISSUE AA

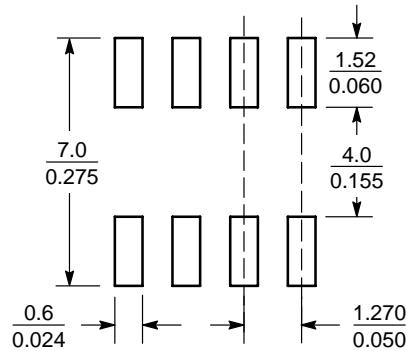


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. 751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07

| DIM | MILLIMETERS | | INCHES | |
|-----|-------------|------|-----------|-------|
| | MIN | MAX | MIN | MAX |
| A | 4.80 | 5.00 | 0.189 | 0.197 |
| B | 3.80 | 4.00 | 0.150 | 0.157 |
| C | 1.35 | 1.75 | 0.053 | 0.069 |
| D | 0.33 | 0.51 | 0.013 | 0.020 |
| G | 1.27 BSC | | 0.050 BSC | |
| H | 0.10 | 0.25 | 0.004 | 0.010 |
| J | 0.19 | 0.25 | 0.007 | 0.010 |
| K | 0.40 | 1.27 | 0.016 | 0.050 |
| M | 0° | 8° | 0° | 8° |
| N | 0.25 | 0.50 | 0.010 | 0.020 |
| S | 5.80 | 6.20 | 0.228 | 0.244 |

SOLDERING FOOTPRINT*



SCALE 6:1 $\left(\frac{\text{mm}}{\text{inches}} \right)$

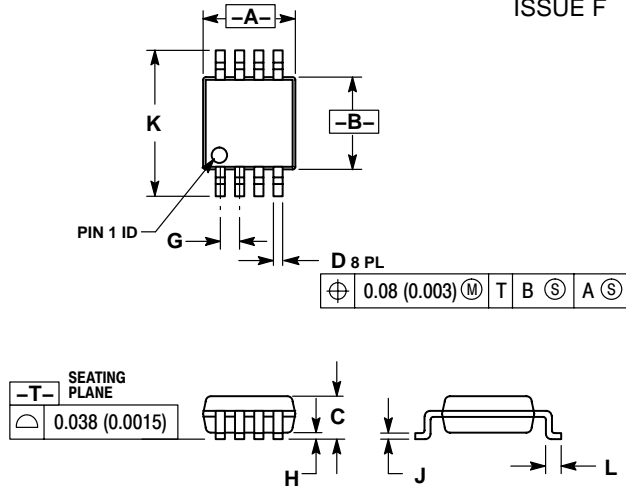
SOIC-8

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

MC33201, MC33202, MC33204, NCV33202, NCV33204

PACKAGE DIMENSIONS

Micro8
DM SUFFIX
CASE 846A-02
ISSUE F



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. 846A-01 OBSOLETE, NEW STANDARD 846A-02.

| DIM | MILLIMETERS | | INCHES | |
|-----|-------------|------|-----------|-------|
| | MIN | MAX | MIN | MAX |
| A | 2.90 | 3.10 | 0.114 | 0.122 |
| B | 2.90 | 3.10 | 0.114 | 0.122 |
| C | --- | 1.10 | --- | 0.043 |
| D | 0.25 | 0.40 | 0.010 | 0.016 |
| G | 0.65 BSC | | 0.026 BSC | |
| H | 0.05 | 0.15 | 0.002 | 0.006 |
| J | 0.13 | 0.23 | 0.005 | 0.009 |
| K | 4.75 | 5.05 | 0.187 | 0.199 |
| L | 0.40 | 0.70 | 0.016 | 0.028 |

STYLE 1:

- PIN 1: SOURCE
2. SOURCE
3. SOURCE
4. GATE
5. DRAIN
6. DRAIN
7. DRAIN
8. DRAIN

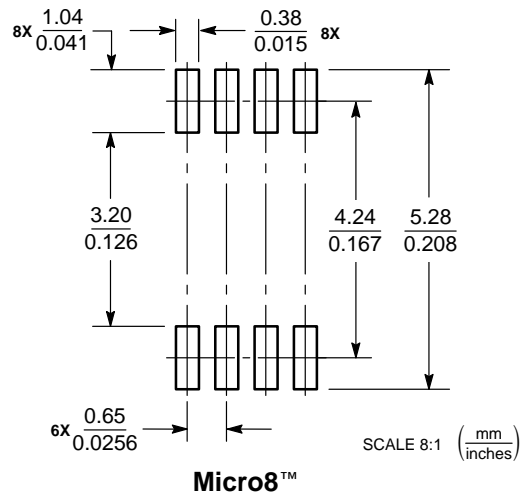
STYLE 2:

- PIN 1: SOURCE 1
2. GATE 1
3. SOURCE 2
4. GATE 2
5. DRAIN 2
6. DRAIN 2
7. DRAIN 1
8. DRAIN 1

STYLE 3:

- PIN 1: N-SOURCE
2. N-GATE
3. P-SOURCE
4. P-GATE
5. P-DRAIN
6. P-DRAIN
7. N-DRAIN
8. N-DRAIN

SOLDERING FOOTPRINT*



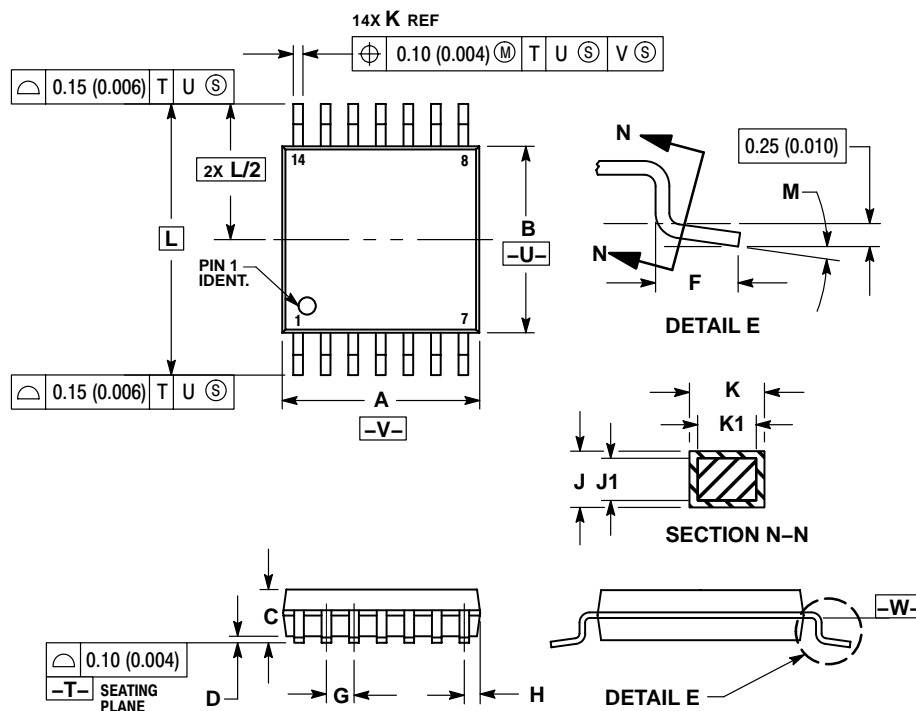
Micro8™

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

MC33201, MC33202, MC33204, NCV33202, NCV33204

PACKAGE DIMENSIONS

TSSOP-14
DTB SUFFIX
CASE 948G-01
ISSUE O




NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

| DIM | MILLIMETERS | | INCHES | |
|-----|-------------|------|-----------|-------|
| | MIN | MAX | MIN | MAX |
| A | 4.90 | 5.10 | 0.193 | 0.200 |
| B | 4.30 | 4.50 | 0.169 | 0.177 |
| C | --- | 1.20 | --- | 0.047 |
| D | 0.05 | 0.15 | 0.002 | 0.006 |
| F | 0.50 | 0.75 | 0.020 | 0.030 |
| G | 0.65 BSC | | 0.026 BSC | |
| H | 0.50 | 0.60 | 0.020 | 0.024 |
| J | 0.09 | 0.20 | 0.004 | 0.008 |
| J1 | 0.09 | 0.16 | 0.004 | 0.006 |
| K | 0.19 | 0.30 | 0.007 | 0.012 |
| K1 | 0.19 | 0.25 | 0.007 | 0.010 |
| L | 6.40 BSC | | 0.252 BSC | |
| M | 0° | 8° | 0° | 8° |

Micro8 is a trademark of International Rectifier.

ON Semiconductor and  are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor
P.O. Box 5163, Denver, Colorado 80217 USA
Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada
Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada
Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free
USA/Canada

Japan: ON Semiconductor, Japan Customer Focus Center
2-9-1 Kamimeguro, Meguro-ku, Tokyo, Japan 153-0051
Phone: 81-3-5773-3850

ON Semiconductor Website: <http://onsemi.com>

Order Literature: <http://www.onsemi.com/litorder>

For additional information, please contact your local Sales Representative.

This datasheet has been downloaded from:

www.EEworld.com.cn

Free Download

Daily Updated Database

100% Free Datasheet Search Site

100% Free IC Replacement Search Site

Convenient Electronic Dictionary

Fast Search System

www.EEworld.com.cn